## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## METHOD OF FORMING BOND MICROSTRUCTURE

_X	is attached hereto.				
	was filed on				
	as Application Seri	al No	and was amended on		·
apı apı for	ecification, including t I acknowledge the olication in accordanc I hereby claim fore olication(s) for paten	he claims, as amended duty to disclose inforce with Title 37, Code of ign priority benefits under the inventor's certificatent or inventor's certificatent.	nd understand the content of by any amendment referred mation which is material to of Federal Regulations, § 1. der Title 35, United States Co ate listed below and have ficate having a filing date be	ed to above.  the patent  56(a).  code, § 119  also identifi	ability of this of any foreigr ed below any
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
	92135508	Taiwan, R.O.C.	2003/12/16	Х	
traı	I hereby appoint the following attorney(s isact all business in the Patent and Tradem  Belinda Lee (Reg. No. 46,86  Jiawei Huang (Reg. No. 43,33  Charles C.H. Wu (Reg. No. 39,08		ark Office connected therev  3) Charles Liu  0)		
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			fice	Belinda Lee	

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## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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